

## 2N4403







# **PNP General Purpose Amplifier**

This device is designed for use as a general purpose amplifier and switch requiring collector currents to 500 mA.

### **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CEO}$	Collector-Emitter Voltage	40	V
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V
Ic	Collector Current - Continuous	600	mA
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

1) These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

#### **Thermal Characteristics**

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		2N4403	*MMBT4403	
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	mW mW/°C
R <sub>θJC</sub>	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

<sup>\*</sup>Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

1.0

100

μmhos

Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHA	RACTERISTICS				
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	40		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 0.1 \text{ mA}, I_E = 0$	40		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 0.1 \text{ A}, I_C = 0$	5.0		V
I <sub>BEX</sub>	Base Cutoff Current	V <sub>CE</sub> = 35 V, V <sub>EB</sub> = 0.4 V		0.1	μА
I <sub>CEX</sub>	Collector Cutoff Current	V <sub>CE</sub> = 35 V, V <sub>BE</sub> = 0.4 V		0.1	μА
		$I_C = 150 \text{ mA}, V_{CE} = 2.0 \text{ V}^*$	100	300	
ON CHAR	RACTERISTICS DC Current Gain	$I_{C} = 0.1 \text{ mA}, V_{CE} = 1.0 \text{ V}$	30		
		$I_C = 10 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_C = 150 \text{ mA}, V_{CE} = 2.0 \text{ V}^*$	100 100	300	
		$I_C = 500 \text{ mA}, V_{CE} = 2.0 \text{ V}^*$	20		
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage*	$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$ $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.4 0.75	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 150 mA, I <sub>B</sub> = 15 mA*	0.75	0.75	V
- DE(Oat)		$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		1.3	V
SMALL SI	GNAL CHARACTERISTICS  Current Gain - Bandwidth Product	I <sub>C</sub> = 20 mA, V <sub>CE</sub> = 10 V, f = 100 MHz	200		MHz
C <sub>cb</sub>	Collector-Base Capacitance	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 140 kHz		8.5	pF
C <sub>eb</sub>	Emitter-Base Capacitance	$V_{BE} = 0.5 \text{ V}, I_{C} = 0,$ f = 140 kHz		30	pF
Ίie	Input Impedance	$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 1.0  kHz	1.5	15	kΩ
h <sub>re</sub>	Voltage Feedback Ratio	$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 1.0  kHz	0.1	8.0	x 10 <sup>-4</sup>
h <sub>fe</sub>	Small-Signal Current Gain	$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 1.0  kHz	60	500	
	Output Admittance	$I_0 = 1.0 \text{ m/s} \text{ V/s} = 10 \text{ V/s}$	1.0	100	

#### **SWITCHING CHARACTERISTICS**

Output Admittance

hoe

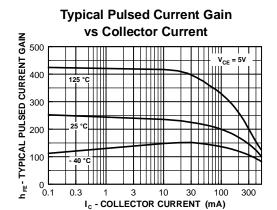
t <sub>d</sub>	Delay Time	$V_{CC} = 30 \text{ V}, I_{C} = 150 \text{ mA},$	15	ns
t <sub>r</sub>	Rise Time	I <sub>B1</sub> = 15 mA	20	ns
ts	Storage Time	$V_{CC} = 30 \text{ V}, I_{C} = 150 \text{ mA}$	225	ns
t <sub>f</sub>	Fall Time	$I_{B1} = I_{B2} = 15 \text{ mA}$	30	ns

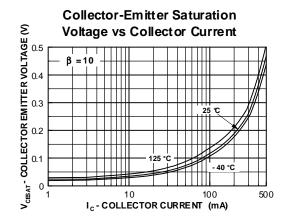
 $I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 1.0 kHz

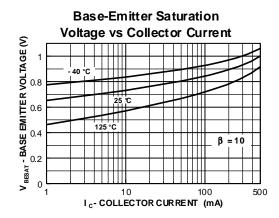
<sup>\*</sup>Pulse Test: Pulse Width £ 300 ms, Duty Cycle £ 2.0%

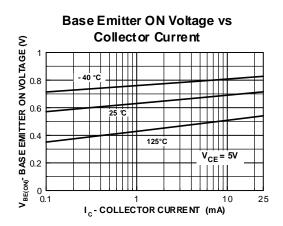
(continued)

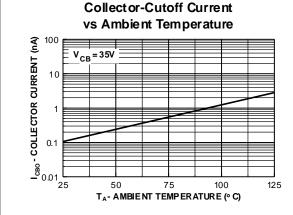
### **Typical Characteristics**

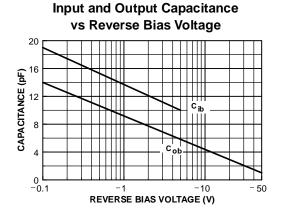








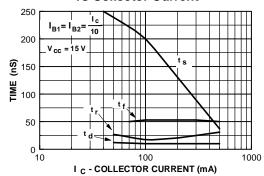




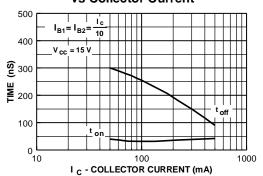
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### Typical Characteristics (continued)

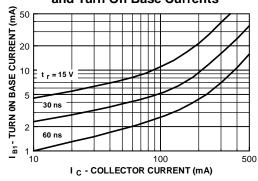
Switching Times vs Collector Current



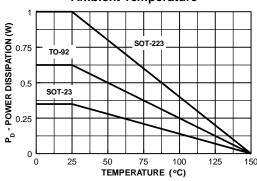
Turn On and Turn Off Times vs Collector Current



Rise Time vs Collector and Turn On Base Currents

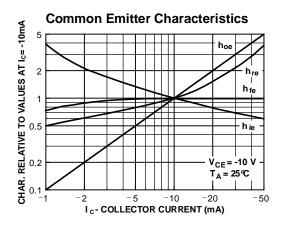


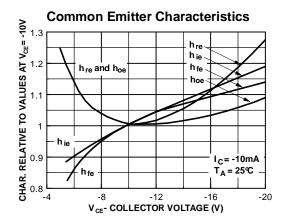
Power Dissipation vs Ambient Temperature

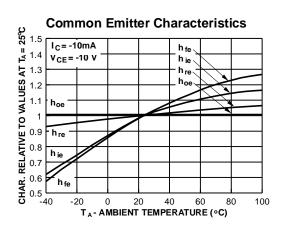


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### **Typical Common Emitter Characteristics** (f = 1.0kHz)







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### **Test Circuits**

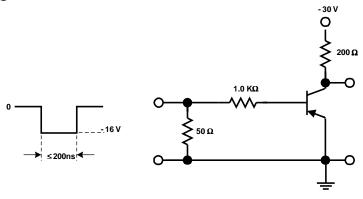


FIGURE 1: Saturated Turn-On Switching Time Test Circuit

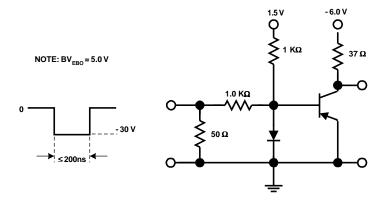


FIGURE 2: Saturated Turn-Off Switching Time Test Circuit

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